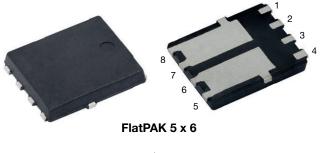
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LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2 x 4 A				
V _R	200 V				
V _F at I _F	0.7 V				
t _{rr (typ.)}	25 ns				
T _J max.	175 °C				
Package	FlatPAK 5 x 6				
Circuit configuration	Separated cathode				

FEATURES

• Hyperfast recovery time, reduced Q_{rr}, and soft recovery



HALOGEN

FREE

- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- Low forward voltage drop
- · Low leakage current
- Meets MSL level 1 per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in snubber, boost, piezo-injection, as high frequency rectifiers, and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

MECHANICAL DATA

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

ABSOLUTE MAXIMUM RATINGS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Peak repetitive reverse voltage		V _{RRM}		200	V		
Average rectified forward current	per device	I _{F(AV)}	T _{Solderpad} = 170 °C, DC	8	А		
Average rectilied forward current	per device		T _{Solderpad} = 169 °C, D = 0.5	0			
Non-repetitive peak surge current -	per device		T,I = 25 °C, 10 ms sinusoidal pulse	173	A		
Non-repetitive peak surge current -	per diode	I _{FSM}	1j = 25 C, 10 ms sinusoidai puise	87			
Operating junction and storage tem	nperatures	T _J , T _{Stg}		-55 to +175	°C		

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-			
	V _F	$I_F = 4 A$	-	0.87	0.96	V		
Forward voltage, per diode		I _F = 4 A, T _J = 150 °C	-	0.7	0.78			
Reverse leakage current, per diode		$V_{R} = V_{R}$ rated	-	-	2	uА		
neverse leakage current, per diode	I _R	T _J = 150 °C, V _R = V _R rated	-	7	80	μΑ		
Junction capacitance	CT	V _R = 200 V	-	19	-	pF		

Revision: 29-Jan-2021

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Document Number: 96090

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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CC	NDITIONS	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	= 50 A/µs, V _R = 30 V	-	20	-			
Reverse recovery time	+	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$		-	-	25			
	t _{rr}	T _J = 25 °C		-	17	-	- ns - A		
		T _J = 125 °C		-	29	-			
Deels receiver a current	I _{RRM}	T _J = 25 °C	$I_F = 4 A$	-	2.1	-			
Peak recovery current		T _J = 125 °C	dl _F /dt = 200 A/µs V _B = 160 V	-	4	-			
	0	T _J = 25 °C		-	18	-			
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	60	-	nC		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C	
Thermal resistance, junction to ambient, per diode	R _{thJA} ⁽¹⁾⁽²⁾		-	89	103	°C/W	
Thermal resistance, junction to mount, per diode	R _{thJM} ⁽³⁾		-	1.8	2.1	0/10	

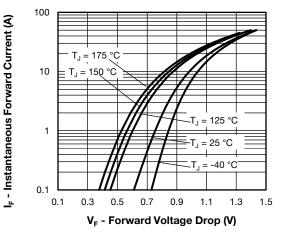
Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{thJA}$

 $^{(2)}$ Free air, mounted or recommended copper pad area; thermal resistance R_{thJA} - junction to ambient

⁽³⁾ Mounted on infinite heatsink





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Fig. 1 - Typical Forward Voltage Drop Characteristics

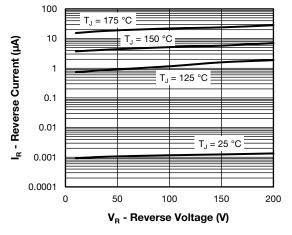


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

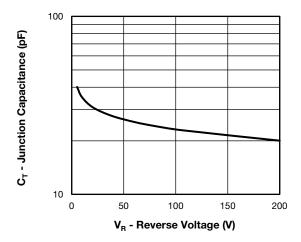


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

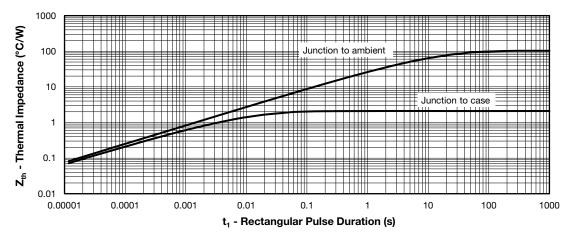
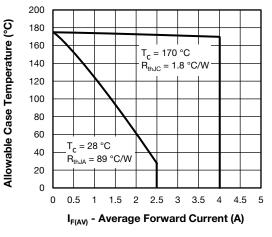


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

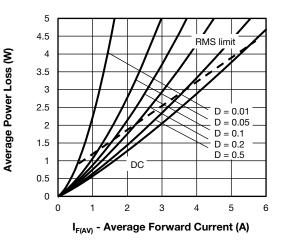


Fig. 6 - Forward Power Loss Characteristics

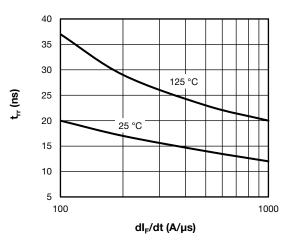


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

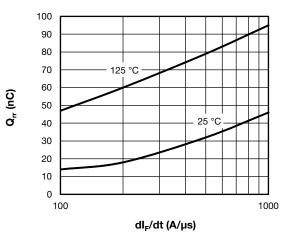


Fig. 8 - Typical Stored Charge vs. dl_F/dt

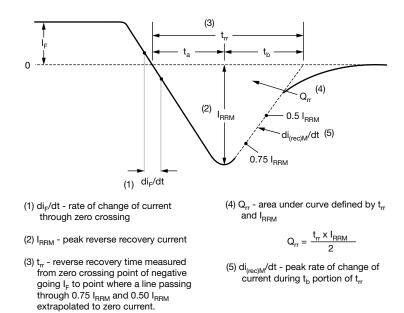


Fig. 9 - Reverse Recovery Waveform and Definitions

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ORDERING INFORMATION TABLE

Device code	VS-	8	D	к	н	02	-M3
	1	2	3	4	5	6	7
	1	- Visl	hay Sen	niconduo	ctors pro	oduct	
	2	- Cur	rent rati	ng (8 =	8 A)		
	3	- Circ	cuit conf	iguratior	ו:		
		D =	separat	ed cath	ode		
	4	- K=	FlatPA	<pre>K packag</pre>	ge		
	5	- Pro	cess typ	e,			
		H =	hyper fa	ast reco	very		
	6	- Vol	tage coo	le (02 =	200 V)		
	8	M3	s = halog	gen-free	, RoHS	complia	ant, and

ORDERING INFORMATION (example)							
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE QUANTITY PACKAGING DESCRIPTIC							
VS-8DKH02-M3/H	0.10	н	1500	7"diameter plastic tape and reel			
VS-8DKH02-M3/I	0.10	I	6000	13"diameter plastic tape and reel			

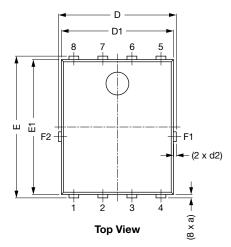
LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?96056</u>				
Part marking information	www.vishay.com/doc?96059			
Packaging information	www.vishay.com/doc?88869			

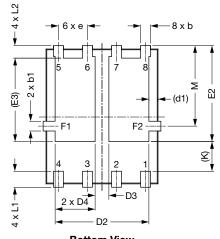




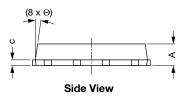
FlatPAK 5 x 6 (Dual)

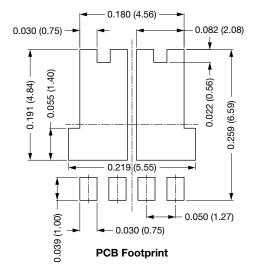
DIMENSIONS in inches (millimeters)











DIM		INCHES		MILLIMETERS		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.035	0.039	0.043	0.89	0.99	1.09
(a)	-	0.006	-	-	0.15	-
b	0.013	0.017	0.020	0.32	0.43	0.52
b1	0.013	0.017	0.020	0.32	0.43	0.52
С	0.008	-	0.014	0.20	-	0.35
D	0.197	0.203	0.209	5.00	5.15	5.30
D1	0.189	0.193	0.197	4.80	4.90	5.00
D2	0.154	0.161	0.169	3.90	4.10	4.30
D3	0.020	0.024	0.031	0.50	0.60	0.80
D4	0.063	0.069	0.075	1.60	1.75	1.90
(d1)	-	0.016	-	-	0.40	-
(d2)	-	0.005	-	-	0.125	-
E	0.238	0.244	0.250	6.05	6.20	6.35

Revision: 27-Mar-18

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Document Number: 96056

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Outline Dimensions



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DIM.		INCHES			MILLIMETERS		
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
E1	0.228	0.232	0.236	5.80	5.90	6.00	
E2	0.157	0.165	0.173	4.00	4.20	4.40	
(E3)	-	0.144	-	-	3.65	-	
е		0.050 BSC		1.27 BSC			
(K)	0.039	-	-	1.00	-	-	
L1	0.019	-	0.043	0.48	-	1.10	
L2	0.012	-	0.031	0.30	-	0.80	
М	0.128	0.138	0.148	3.25	3.50	3.75	
Θ	0°	-	10°	0°	-	10°	

Notes

٠ Dimensioning and tolerancing per ASME Y14.5-2009

Dimensions D1 and E1 do not include mold flash or gate burrs ٠

Dimension (XX) means reference only ٠



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Revision: 01-Jan-2025

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